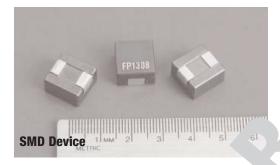
Effective June 2017 Supersedes Sepetember 2011

FP1308 High frequency, high current power inductors



Product features

- 13.7 x 12.9 x 8.0mm surface mc аск. је
- High current handling capability on
- footprint
- Ferrite core material
- Inductance range from (10µ + 0.5 µH
- Current range from 32 to 2 m
- Frequency range up ?Ni
 Halogen free, leac' e∈ 30H5 pliant

Applications

- Voltage regulator modules (VRMs) for servers and microprocessors
- Multi-phase buck tors
- h/ High frequency * switching power

supplies

Enviro nerta.

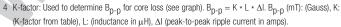
- Stor. inperature range (component): -40 °C ւ∟ `?5 °C
- Operatingperatur range: -40 °C to +125 °C bient plus self- inperature rise)
- r reflow tem, Su
 - -020 (lat I-S revision) cc pliant

Product Specifications							
Part	Rated	OCL ¹	Irms ²	Isat ³	DCR (mΩ) @	DCR (mΩ) @	K-factor ^₄
Number⁵	Inductance (µH)	± 10% (μH)	(Amps)	(Amps)	25°C Typical	25°C Max	
FP1308-R11-R	0.110	0.110	68	120	0.20	0.24	21.330
FP1308-R21-R	0.210	0.210	68	72	0.20	0.24	21.333
FP1308-R26-R	0.260	0.260	68	60	0.20	0.24	21.335
FP1308-R32-R	0.320	0.320	68	45	0.20	0.24	21.340
FP1308-R44-R	0.440	0.440	68	32	0.20	0.24	21.366

1 Open Circuit Inductance (OCL) Test Parameters: 100kHz, 1.0V_{rms}, 0.0Adc

2 Irms: DC current for an approximate temperature rise of 40°C without core loss. Derating is necessary for AC currents. PCB pad layout, trace thickness and width, air-flow and proximity of other heat generating components will affect the temperature rise. It is recommended the part temperature not exceed 125°C under worst case operating conditions verified in the end application.

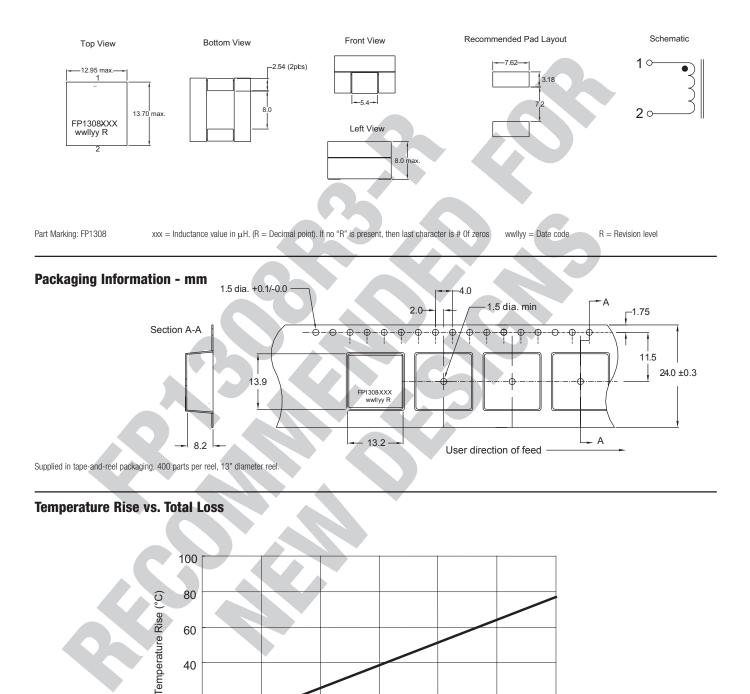
3 Isat: Peak current for approximately 20% rolloff at +25°C.



- Part Number Definition: FP1308-xxx-R
- FP1308 = Product code and size
- xxx= Inductance value in μ H, R = decimal point. If no "R" is present, then
- third character = # of zeros. • "-R" suffix = RoHS compliant



Dimensions - mm



20

0

0.5

1

1.5

Total Loss (W)

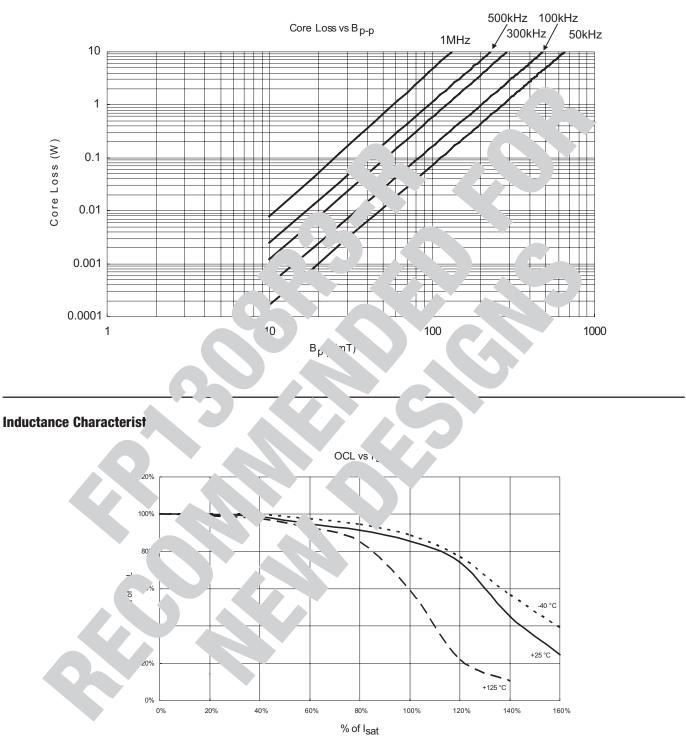
2

3

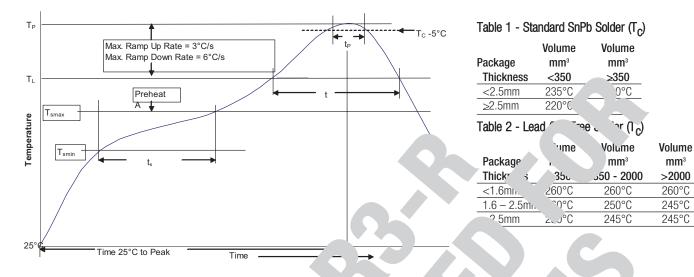
2.5

FP1308 High frequency, high current power inductors

Core Loss



Solder Reflow Profile



Reference JDEC J-STD-020

Profile Feature	یتم. ۲۰ کی Solder	Tree Solder	
Preheat and Soak • Temperature min. (T _{Sr}		150°C	
• Temperature max. $(T_{s} \neq)$	50°C	200°C	
Time (T _{smin} to T)	66 120 Se 1s	60-120 Seconds	
Average ramp up rate T _{smax} to T _p	C/Ser 1ML	3°C/ Second Max.	
Liquidous temperature (TL)	<u>3°</u> C	217°C	
Time at liquidous (t _L)	60 15 Jun	60-150 Seconds	
Peak package body temperature (1p)*	Trhle 1	Table 2	
Time (tp)** within 5 °C of the spy ied classification one tu. To	.ecor 's**	30 Seconds**	
Average ramp-down rate () and () max)	d Max.	6°C/ Second Max.	
Time 25°C to Peak Te Jera''Ire	L inutes Max.	8 Minutes Max.	

* Tolerance for peak prove operature (Tp) is red a rollier minimum and a sximum.

** Tolerance for time at peak point temperature is indias a supply minimum and a user maximum.

npan

 The support systems are devices which support or sustain life, and whose failure to perform, when properly is for use provided in the labeling, can be reasonably expected to result in significant inju y to the user.

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